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(	FORM <b>PTO-1595</b> OCT 2 8 SOURCE (C) Rev. 6-93)  OMB No. 0651-001

## 11-03-1999

SHEET U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

101190909					
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Name of conveying party(ies):	Name and address of receiving party(ies)				
Radhika Thekkath G. Michael Uhler	MIPS Technologies 1225 Charleston Road Mountain View, CA 94043-1353				
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3. Nature of conveyance:  ☐ Assignment ☐ Merger ☐ Security Agreement ☐ Change of Name	Additional name(s) & address(es) attached?				
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If this document is being filed together with a new application, the execution date of the application is:					
A. Patent Application No.(s)	B. Patent No.(s)				
09/373093 - MIPS:19427A-009500					
Additional numbers attached?   Yes  No					
<ol> <li>Name and address of party to whom correspondence concerning document should be mailed:</li> </ol>	6. Total number of applications and patents involved 1				
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James W. Huffman 106 Morning Cloud Austin, TX 78734	A check in the amount of \$40 is attached hereto				
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Washington, D.C. 20231

Docket Number: MIPS:19427A-009500

## **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on 08/12/1999;

AND WHEREAS, **MIPS Technologies, Inc.** together with any successors, legal representatives, or assigns thereof, with its principal office at 1225 Charleston Road, Mountain View, CA 94043-1389, wants to acquire the entire right, title and interest in and to the said invention(s), and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledge, I have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to the said MIPS Technologies, Inc., its successors and assigns, the entire right, title and interest in and to the said invention and in and to the said application and all patents which may be granted thereon, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I/we hereby authorize and request the Commissioner of Patents, and any officials of foreign countries whose duty it is to issue patents on applications, to issue all patents for said invention, or patents resulting therefrom, insofar as my interest in concerned, to the said MIPS Technologies, Inc. as assignee of my entire right, title and interest;

I ALSO HEREBY sell and assign to MIPS Technologies, Inc., its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights;

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant that I will communicate to said MIPS Technologies, Inc. or to its successors, assigns and legal representatives, any facts known to me respecting said invention, and at the expense of said MIPS Technologies, Inc. testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said MIPS Technologies, Inc., its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand this day and year:

TITLE OF INVENTION	DATA RELEASE TO REDUCE LATENCY IN ON-CHIP SYSTEM BUS			
NAME OF INVENTOR	RESIDENCE (City, State)	SIGNATURE	DATE	
Radhika Thekkath	919 Clara Drive Palo Alto, CA 94303	Wall.	10 14 99	
G. Michael Uhler	8 Sequoia Ct. Redwood City, CA 94061	In	10/14/21	

After recording, return Assignment to:

ATTN: JAMES W. HUFFMAN 106 Morning Cloud, Austin, TX 78734

PATENT
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